

Ordering Information (Note 4)

	_					
Logic Devic 74 : Logic Prefi LVC : 1.65 to 5.5 \ Logic Famil 1G : One Gate	x /	Functior 00 : 2-Input AND Gate	Packag W5 : SOT25 SE : SOT353 Z : SOT553 FS3 : X2-DFN0 FW5 :X1-DFN1 FW4 :X2-DFN1 FX4 : X2- DFN1 FZ4 : X2- DFN1	-7 : 7" Ta 808-4 010-6 (Type B) 010-6 1409-6	∕acking pe & Reel	
	Package	Package	Package	7" Tape and Reel		
Part Number	Code	(Notes 5 & 6)	Size	Quantity	Part Number Suffix	
74LVC1G00W5-7	W5	SOT25	3.0mm x 2.8mm x 1.2mm 0.95 mm lead pitch	3,000/Tape & Reel	-7	
74LVC1G00SE-7	SE	SOT353	2.0mm x 2.0mm x 1.1mm 0.65 mm lead pitch	3,000/Tape & Reel	-7	
74LVC1G00Z-7	Z	SOT553	1.6mm x 1.6 mm x 0.62mm 0.5 mm lead pitch	4,000/Tape & Reel	-7	
74LVC1G00FS3-7	FS3	X2-DFN0808-4	0.8mm x 0.8mm x 0.35mm 0.5 mm pad pitch (diamond)	5,000/Tape & Reel	-7	
74LVC1G00FW5-7	FW5	X1-DFN1010-6 (Type B)	1.0mm x 1.0mm x 0.5mm 0.35 mm pad pitch	5,000/Tape & Reel	-7	
74LVC1G00FW4-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35 mm pad pitch	5,000/Tape & Reel	-7	
74LVC1G00FX4-7	FX4	X2-DFN1409-6 Chip scale alternative	1.4mm x 0.9mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7	
74LVC1G00FZ4-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7	

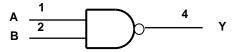
Notes:

For packaging details, go to our website at http://www.diodes.com/products/packages.html.
Pad layout as shown in Diodes Inc. suggested pad layouts, which can be found on our website at see http://www.diodes.com/package-outlines.html.
The taping orientation is located on our website at http://www.diodes.com/package-outlines.html.

Pin Descriptions

Pin Name	Description	
А	Data Input	
В	Data Input	
GND	Ground	
Y	Data Output	
Vcc	Supply Voltage	
NC	No Connection	

Logic Diagram



Function Table

Inp	Output	
Α	В	Y
Н	Н	L
L	Х	Н
Х	L	Н



Absolute Maximum Ratings (Notes 7 & 8)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or IOFF state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.5 to V _{CC} +0.5	V
lıк	Input Clamp Current VI<0	-50	mA
I _{ОК}	Output Clamp Current	-50	mA
lo	Continuous Output Current	±50	mA
ICC, IGND	Continuous current through V _{CC} or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

 Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.. Notes:

Symbol		Parameter	Min	Max	Unit	
<i>\</i>		Operating	1.65	5.5	V	
Vcc	Operating Voltage	Data retention only	1.5	_	V	
		V _{CC} = 1.65V to 1.95V	0.65 x V _{CC}	—		
N/	Lligh Lovel Input Veltage	V _{CC} = 2.3V to 2.7V	1.7	—	v	
VIH	High-Level Input Voltage	$V_{CC} = 3V \text{ to } 3.6V$	2	—	v	
		$V_{CC} = 4.5V$ to 5.5V	0.7 x V _{CC}	—		
		V _{CC} = 1.65V to 1.95V	—	0.35 x V _{CC}		
		V _{CC} = 2.3V to 2.7V	—	0.7	v	
VIL	Low-Level Input Voltage	$V_{CC} = 3V \text{ to } 3.6V$	—	0.8	v	
		V _{CC} = 4.5V to 5.5V	—	0.3 x V _{CC}		
VI		Input Voltage	0	5.5	V	
Vo		Dutput Voltage	0	V _{CC}	V	
		V _{CC} = 1.65V	—	-4		
		V _{CC} = 2.3V	—	-8		
1	High-Level Output Current	V _{CC} = 2.7V	—	-12	mA	
I _{ОН}		V _{CC} = 3V	_	-16		
		V _{CC} = 3V	—	-24		
		$V_{CC} = 4.5V$	—	-32		
		$V_{CC} = 1.65V$	—	4		
		$V_{CC} = 2.3V$	—	8		
IOL	Low-Level Output Current	$V_{CC} = 2.7 V$	—	12	mA	
IOL		V _{CC} = 3V		16	IIIA	
				24		
		$V_{CC} = 4.5V$	_	32		
	Input Transition Bios or Fall	$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$	_	20		
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 3.3V \pm 0.3V$		10	ns∕∖	
		$V_{CC} = 5V \pm 0.5V$		5		
T _A	Operating Free-Air Temperature	_	-40	+125	°C	

Recommended Operating Conditions (Note 9)

Note: 9. Unused inputs should be held at V_{CC} or Ground.



Electrical Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = +25^{\circ}C$)

Quest of	Demonstern	Test Osmilitisms	N	-40	-40°C to +85°C			-40°C to +125°C	
Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур	Max	Min	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} -0.1	—	—	V _{CC} -0.1	_	
		I _{OH} = -4mA	1.65V	1.2	—	—	0.95	_	
		I _{OH} = -8mA	2.3V	1.9	—	—	1.7	_	
V _{OH}	High Level Output Voltage	I _{OH} = -12mA	2.7V	2.2	—	—	1.9		V
	output voltage	I _{OH} = -16mA	3V	2.4	—	—	2.2		
		I _{OH} = -24mA	50	2.3	_	_	2.0		
		I _{OH} = -32mA	4.5V	3.8	_	_	3.4		
		I _{OL} = 100μA	1.65V to 5.5V	—	—	0.1	—	0.1	
		$I_{OL} = 4mA$	1.65V	—	_	0.45	—	0.45	- - - -
		$I_{OL} = 8mA$	2.3V	—	_	0.3	—	0.3	
Vol	Low Level Output Voltage	$I_{OL} = 12mA$	2.7V	—	_	0.4	—	0.6	
	Output Voltage	$I_{OL} = 16 \text{mA}$	3V	—	—	0.4	—	0.4	
		$I_{OL} = 24mA$	3V	—	_	0.55	—	0.55	
		I _{OL} = 32mA	4.5V	—		0.55	—	0.55	
lı –	Input Current	$V_I = 5.5V$ or GND	0 to 5.5V	—	± 0.1	±5	—	± 5	μA
IOFF	Power Down Leakage Current	$V_{I} \text{ or } V_{O} = 5.5 V$	0V	_	_	±10	_	±10	μΑ
Icc	Supply Current	$V_1 = 5.5V$ or GND $I_0=0$	5.5V	_	0.1	10	_	10	μA
ΔI _{CC}	Additional Supply Current	One input at V_{CC} –0.6V Other inputs at V_{CC} or GND	3V to 5.5V	_	_	500	_	500	μΑ
Ci	Input Capacitance	$V_i = V_{CC} - or GND$	3.3V	_	5	—	—	_	pF

Package Characteristics

Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур.	Max	Unit
		SOT25		-	204	_	
		SOT353		-	371	_	
		SOT553			231	_	
0	Thermal Resistance	X2-DFN0808-4	(Nata 10)		400	_	°C/W
θја	Junction-to-Ambient	X1-DFN1010-6 (Type B)	(Note 10)		435	_	°C/W
		X2-DFN1010-6		-	445	_	
		X2-DFN1409-6		-	470	_	
		X2-DFN1410-6		-	460	_	
		SOT25			52	_	
		SOT353			143	_	
		SOT553			105	_	
0	Thermal Resistance	X2-DFN0808-4	(Nata 40)	-	225	_	
θυς	Junction-to-Case	X1-DFN1010-6 (Type B)	(Note 10)		250	_	°C/W
		X2-DFN1010-6			250	_	
		X2-DFN1409-6			275	_	
		X2-DFN1410-6		_	265	_	

Note: 10. Test condition for each of the 8 package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Switching Characteristics

Parameter	meter From Input	То	V.	ΤA	. = -40°C to 85	°C	T _A = -40°C	C to 125°C	Unit
Farameter		Output	Vcc	Min	Тур	Max	Min	Max	Unit
			1.8V ± 0.15V	1.0	3.3	8.0	1.0	10.5	
			2.5V ± 0.2V	0.5	2.2	5.5	0.5	7.0	
t _{pd}	A or B	Y	2.7V	0.5	2.6	5.8	0.5	7.5	ns
			3.3V ± 0.3V	0.5	2.2	4.7	0.5	6.0	
		$5.0V \pm 0.5V$	0.5	1.8	4.0	0.5	5.5		

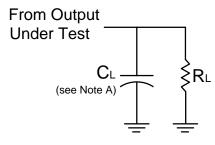
Operating Characteristics

T_A = +25°C

		Parameter	Test Conditions	V _{CC} = 1.8V Typ	V _{CC} = 2.5V Typ	V _{CC} = 3.3V Typ	V _{CC} = 5V Typ	Unit
Ct	pd	Power Dissipation Capacitance	f = 10 MHz	22	22	23	25	pF



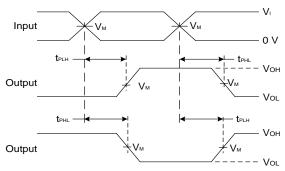
Parameter Measurement Information



Vcc	Inputs		V _M	CL	RL
VCC	VI	t _r /t _f	¥ Wi	σL	κ <u>ι</u>
1.8V ± 0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1ΚΩ
2.5V ± 0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
2.7V	V _{CC}	≤2.5ns	1.5V	50pF	500Ω
3.3V ± 0.3V	3.0V	≤2.5ns	1.5V	50pF	500Ω
5.0V ± 0.5V	V _{CC}	≤2.5ns	V _{CC} /2	50pF	500Ω



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

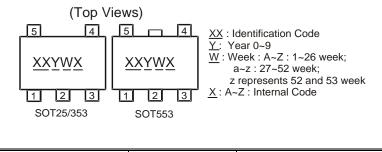
Figure 1. Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance. B. All pulses are supplied at pulse repetition rate \leq 10 MHz.
 - C. Inputs are measured separately one transition per measurement.
 - D. t_{PLH} and t_{PHL} are the same as t_{PD} .



Marking Information

(1) SOT25, SOT353 and SOT553



Part Number	Package	Identification Code
74LVC1G00W5-7	SOT25	US
74LVC1G00SE-7	SOT353	US
74LVC1G00Z-7	SOT553	US

(2) DFN packages

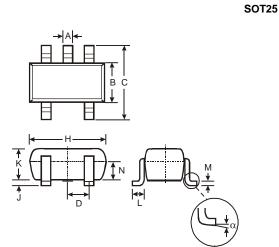


 $\begin{array}{l} \underbrace{XX} : \text{Identification Code} \\ \underline{Y} : Year 0~9 \\ \underline{W} : Week : A~Z : 1~26 week; \\ a~z : 27~52 week; \\ z \text{ represents 52 and 53 week} \\ \underline{X} : A~Z : \text{Internal Code} \end{array}$

Part Number	Package	Identification Code
74LVC1G00FS3-7	X2-DFN0808-4	WS
74LVC1G00FW5-7	X1-DFN1010-6 (Type B)	V2
74LVC1G00FW4-7	X2-DFN1010-6	US
74LVC1G00FX4-7	X2-DFN1409-6	MA
74LVC1G00FZ4-7	X2-DFN1410-6	US



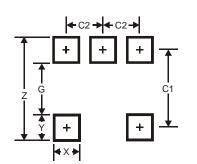
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT25				
Dim	Min	Max	Тур		
Α	0.35	0.50	0.38		
В	1.50	1.70	1.60		
С	2.70	3.00	2.80		
D	-	-	0.95		
н	2.90	3.10	3.00		
J	0.013	0.10	0.05		
к	1.00	1.30	1.10		
L	0.35	0.55	0.40		
М	0.10	0.20	0.15		
Ν	0.70	0.80	0.75		
α	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

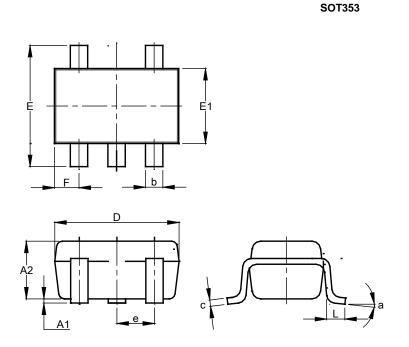


SOT25

Dimensions	Value	
Z	3.20	
G	1.60	
Х	0.55	
Y	0.80	
C1	2.40	
C2	0.95	



Please see http://www.diodes.com/package-outlines.html for the latest version.

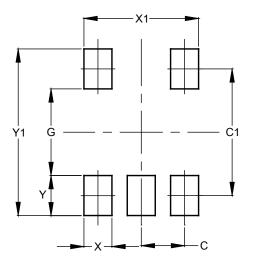


	SOT353				
Dim	Min	Min Max Typ			
A1	0.00	0.10	0.05		
A2	0.90	1.00	1.00		
b	0.10	0.30	0.25		
С	0.10	0.22	0.11		
D	1.80	2.20	2.15		
E	2.00	2.20	2.10		
E1	1.15	1.35	1.30		
е	C).650 B	SC		
F	0.40	0.45	0.425		
L	0.25	0.40	0.30		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

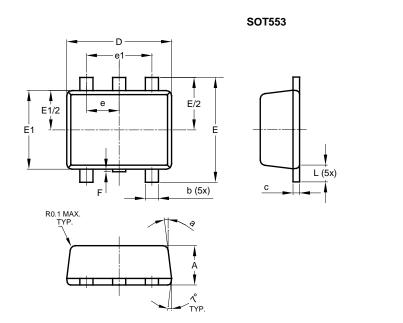
SOT353



Dimensions	Value (in mm)	
С	0.650	
C1	1.900	
G	1.300	
Х	0.420	
X1	1.720	
Y	0.600	
¥1	2.500	



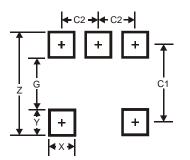
Please see http://www.diodes.com/package-outlines.html for the latest version.



r					
	SOT553				
Dim	Min	Max	Тур		
Α	0.55	0.62	0.60		
b	0.15	0.30	0.20		
С	0.10	0.18	0.15		
D	1.50	1.70	1.60		
Е	1.55	1.70	1.60		
E1	1.10	1.25	1.20		
е	0.50 BSC				
e1	1.	00 BS(C		
F	0.00	0.10			
L	0.10	0.30	0.20		
а	6°	8°	7°		
All Di	mensio	ns in n	nm		

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



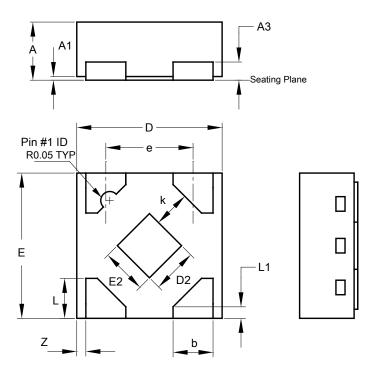
SOT553

Dimensions	Value
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



Please see http://www.diodes.com/package-outlines.html for the latest version.



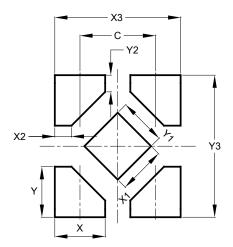


	X2-DFN0808-4				
Dim	Min Max Typ				
Α	0.25	0.35	0.30		
A1	0	0.04	0.02		
A3	-	-	0.13		
b	0.17	0.27	0.22		
D	0.75	0.85	0.80		
D2	0.15	0.35	0.25		
Е	0.75	0.85	0.80		
E2	0.15	0.35	0.25		
е	-	-	0.48		
k	0.20	-	-		
L	0.17	0.27	0.22		
L1	0.02	0.12	0.07		
z	-	-	0.05		
A	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

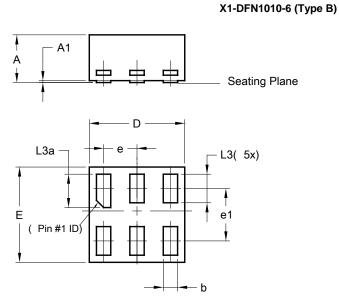
X2-DFN0808-4



Dimensions	Value
С	0.480
Х	0.320
X1	0.300
X2	0.106
X3	0.800
Y	0.320
Y1	0.300
Y2	0.106
Y3	0.900



Please see http://www.diodes.com/package-outlines.html for the latest version.

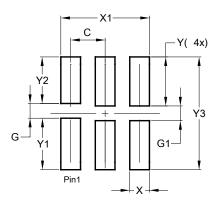


	X1-DFN1010-6 (Type B)				
Dim	Min	Max	Тур		
Α	-	0.50	0.39		
A1	-	0.04	-		
b	0.12	0.20	0.15		
D	0.95	1.050	1.00		
Е	0.95	1.050	1.00		
е	e 0.35 BSC				
e1		0.55 B	SC		
L3	0.27	0.30	0.30		
L3a	0.32	0.40	0.35		
All	Dimen	sions	in mm		

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

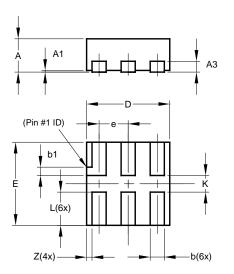
X1-DFN1010-6 (Type B)



Dimensions	Value (in mm)	
С	0.350	
G	0.150	
G1	0.150	
X	0.200	
X1	0.900	
Y	0.500	
Y1	0.525	
Y2	0.475	
Y3	1.150	



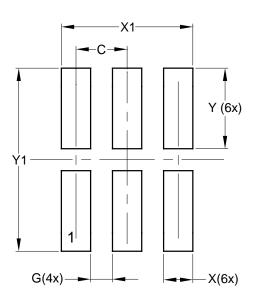
Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1010-6			
Dim	Min	Max	Тур
Α		0.40	0.39
A1	0.00	0.05	0.02
A3			0.13
b	0.14	0.20	0.17
b1	0.05	0.15	0.10
D	0.95	1.05	1.00
E	0.95	1.05	1.00
е			0.35
L	0.35	0.45	0.40
K	0.15		
Z			0.065
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.350
G	0.150
Х	0.200
X1	0.900
Y	0.550
Y1	1.250

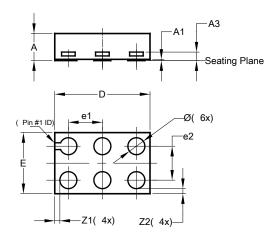
X2-DFN1010-6

X2-DFN1010-6



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X2-DFN1409-6 CHIP SCALE ALTERNATIVE

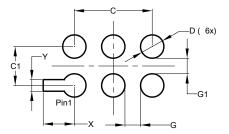


X2-DFN1409-6				
Dim	Min	Max	Тур	
Α	-	0.40	0.39	
A1	0	0.05	0.02	
A3	-	-	0.13	
Ø	0.20	0.30	0.25	
D	1.35	1.45	1.40	
E	0.85	0.95	0.90	
e1	-	-	0.50	
e2	-	-	0.50	
Z1	-	-	0.075	
Z2	-	-	0.075	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

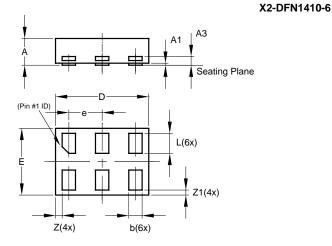
X2-DFN1409-6 CHIP SCALE ALTERNATIVE



Dimensions	Value (in mm)
C	1.000
C1	0.500
D	0.300
G	0.200
G1	0.200
Х	0.400
Ý	0.150



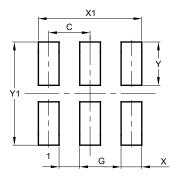
Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1410-6 Dim Min Max Тур 0.40 Α 0.39 A1 0.00 0.05 0.02 A3 0.13 0.25 0.15 b 0.20 D 1.35 1.45 1.40 Ε 0.95 1.05 1.00 е ____ 0.50 0.25 L 0.35 0.30 0.10 Ζ **Z1** 0.045 0.105 0.075 All Dimensions in mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1410-6

Dimensions	Value (in mm)
с	0.500
G	0.250
Х	0.250
X1	1.250
Y	0.525
Y1	1.250



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